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RF6509

2.7V TO 3.6V MODULE FOR INTEGRATION WITH 900MHz SMART ENERGY AMI

Package Style: LGA, 32 pin, 8mm x 8mm x 1.2mm



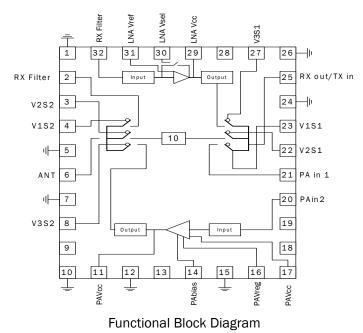
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Features

- Tx Output Power: 29.5dBm
- Tx Gain: 31dBm
- Rx Gain: 18dB
- Rx Noise Figure: 2.5dB
- Integrated LNA with Bypass Mode

Applications

- 868MHz/900MHz ISM Band Application
- Single Chip RF Front End Module
- Portable Battery Powered Equipment
- Wireless Automatic Metering Applications



Product Description

The RF6509 integrates a complete solution in a single Front-End Module (FEM) for AMR and Smart Grid solutions. The RF6509 integrates a 915MHz PA, some transmit (Tx) filtering, input and output switches, a Tx or receive (Rx) attenuation path, and an LNA with bypass mode. The RF6509 has a single-ended input and output for optimized ease of use and implementation. The pin-out of the FEM enables users to implement additional filtering external to the module, if needed. The device is provided in a LGA, 32 pin, 8mm x 8mm x 1.2mm package.

Ordering Information

RF65092.7V to 3.6V Module for Integration with 900MHz Smart
Energy AMIRF6509PCK-410Fully Assembled Evaluation Board and 5 loose pieces.

Optimum Technology Matching® Applied

🗹 GaAs HBT	□ SiGe BiCMOS	🗹 GaAs pHEMT	🗌 GaN HEMT
GaAs MESFET	Si BiCMOS	🗌 Si CMOS	BIFET HBT
InGaP HBT	SiGe HBT	🗌 Si BJT	

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Absolute Maximum Ratings

Parameter	Rating	Unit
Overall		
DC Supply Voltage	+5.0	V
Operating Ambient Temperature	-40 to +85	°C
Storage Temperature	-40 to +150	°C
Low Noise Amplifier		
DC Supply Current	32	mA
Input RF Power	5	dBm
Power Amplifier		
DC Supply Current	1200	mA
Input RF Power	10	dBm
Transmit/Receive Switch		
Input RF Power	33	dBm



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

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RoHS (Restriction of Hazardous Substances): Compliant per EU Directive 2002/95/EC.

Devementer		Specification		Unit	Condition		
Parameter	Min.	Тур.	Max.	Unit	Condition		
Overall					T = 25 °C, PAV _{CC1} and PAV _{CC1} = 3.2V, PA _{BIAS} = 3.2V PAV _{REG} = 2.85V, unless otherwise noted		
Usable Frequency Range	868	902 to 928		MHz			
Input Impedance		50		Ω			
Input VSWR		2:1					
Output Load VSWR		6:1					
PA Section							
CW Output Power	29	29.5		dBm	PA _{BIAS} , P _{IN} = -3 < 0 < 3dBm		
Small Signal Gain	29	31		dB	PA _{BIAS} , P _{IN} = -20dBm		
Second Harmonic		-42.5		dBc	PA _{BIAS} , P _{OUT} = 29.5dBm at ANT port		
Third Harmonic		-72.5		dBc	PA _{BIAS} , P _{OUT} = 29.5dBm at ANT port		
Fourth Harmonic		-42.5		dBc	PA _{BIAS} , P _{OUT} = 29.5dBm at ANT port		
Input VSWR		2:1					
Output VSWR		6:1			Oscillations <-60dBc		
Power Supply Voltage	2.7	3.2	3.6	V			
Power Supply Current		730	850	mA	PA _{BIAS}		
		70	100	μΑ	V_{CCPA} = 3.2V, PA_{BIAS} = 3.2V, PAV_{REG} = 0V,		
Power Supply Current for PA V_{BIAS}		18.0	20.0	mA			
Power Supply Current for PA V_{REG}		70.0	100.0	μΑ			
LNA Section							
HIGH GAIN MODE					$ LNAV_{CC} = 3.0V, LNAV_{REF} = 3.0V, LNAV_{SEL} = $		
Gain	17.5	18	18.5	dB	902MHz to 928MHz		
	15.5	16.5	17.5	dB	868MHz		
Noise Figure		2.4	3.4	dB			
Input IP3	7.5	9.5	12	dBm			
Output VSWR	1.6:1	2:1	2.4:1				
Supply Current			12	mA			





Parameter		Specificatio	n	11	O and it is a		
Parameter	Min.	Тур.	Max.	Unit	Condition		
LNA Section (continued)							
LOW GAIN MODE					$\label{eq:LNAV} \begin{array}{l} {\sf LNAV}_{\sf CC} = 3.0{\sf V}, {\sf LNAV}_{\sf REF} = 3.0{\sf V}, {\sf LNAV}_{\sf SEL} = \\ {\sf 0.0V}, {\sf PA}_{\sf BIAS} = 0.0{\sf V}, {\sf PAV}_{\sf REG} = 0.0{\sf V} \end{array}$		
Gain		-6		dB			
Noise Figure		6		dB			
Supply Current		3		mA			
LNAV _{CC} Voltage	2.7	3.0		V			
LNAV _{REF} Logic Level HIGH	2.7	3.0		V			
LNAV _{REF} Logic Level LOW	0.0		0.3	V			
LNAV _{SEL} Logic Level HIGH	1.8	3.0		V			
LNAV _{SEL} Logic Level LOW			0.8	V			
Power Down Current			10	μΑ	LNA_EN = LOW, LNAV _{SEL} = LOW		
Transceiver Switch Section							
Insertion Loss TXin-PAin	0.9	1	1.1	dB	V _{1S1} = 3.0V, V _{2S1} = 0.0V, V _{3S1} = 0.0V		
Isolation TXin-PAin	25	27		dB	$V_{1S1} = 0.0V, V_{2S1} = 3.0V, V_{3S1} = 0.0V \text{ or}$ $V_{1S1} = 0.0V, V_{2S1} = 0.0V, V_{3S1} = 3.0V$		
TXin/RXout Return Loss (Thru path)		-15	-14	dB	$V_{1S1} = 0.0V, V_{2S1} = 3.0V, V_{3S1} = 0.0V$ and $V_{1S2} = 0.0V, V_{2S2} = 3.0V, V_{3S2} = 0.0V$		
TXin/RXout Return Loss (Transmit path)'			-9	dB	$V_{1S1} = 3.0V, V_{2S1} = 0.0V, V_{3S1} = 0.0V$ and $V_{1S2} = 0.0V, V_{2S2} = 0.0V, V_{3S2} = 3.0V$		
TXin/RXout Return Loss (Receive path)			-9	dB	$V_{1S1} = 0.0V, V_{2S1} = 0.0V, V_{3S1} = 3.0V$ and $V_{1S2} = 3.0V, V_{2S2} = 0.0V, V_{3S2} = 0.0V$		
Switch Control Logic HIGH	2.7	3.0		V			
Switch Control Logic LOW	0.0		0.4	V			
Switch Control Current		13.0	15.0	μΑ			

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Parameter		Specification	1	Unit	Condition		
Farameter	Min.	Тур.	Max.	Unit	Condition		
Antenna Switch Section							
Insertion Loss ANT-LNAin	0.9	1	1.1	dB	V _{1S2} = 3.0V, V _{2S2} = 0.0V, V _{3S2} = 0.0V		
Isolation ANT-LNAin	25	27		dB	$V_{1S2} = 0.0V, V_{2S2} = 3.0V, V_{3S2} = 0.0V \text{ or}$ $V_{1S2} = 0.0V, V_{2S2} = 3.0V, V_{3S2} = 0.0V$		
ANT Return Loss (Thru Path)		-15	-14	dB	$V_{1S1} = 0.0V, V_{2S1} = 3.0V, V_{3S1} = 0.0V \text{ or}$ $V_{1S2} = 0.0V, V_{2S2} = 3.0V, V_{3S2} = 0.0V$		
ANT Return Loss (Transmit Path)			-9	dB	$V_{1S1} = 3.0V, V_{2S1} = 0.0V, V_{3S1} = 0.0V \text{ or}$ $V_{1S2} = 0.0V, V_{2S2} = 0.0V, V_{3S2} = 3.0V$		
ANT Return Loss (Receive Path)			-9	dB	$V_{1S1} = 0.0V, V_{2S1} = 0.0V, V_{3S1} = 3.0V \text{ or}$ $V_{1S2} = 3.0V, V_{2S2} = 0.0V, V_{3S2} = 0.0V$		
Switch Control Logic HIGH	2.7	3.0		V			
Switch Control Logic LOW	0.0		0.4	V			
Switch Control Current		13.0	15.0	μΑ			



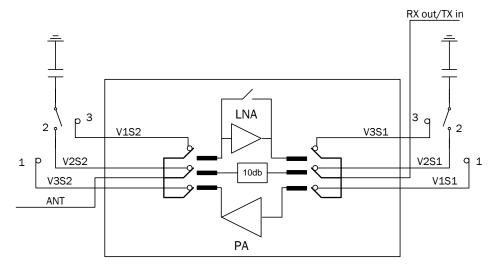
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Pin	Function	Description
1	GND	Ground.
2	RX Filter	RF output to enter the Rx filter (if used), 50 Ω nominal impedance.
	Input	
3	V2S2	Logic input to the Tx Switch arm 2 , selects/deselects thru path if Logic high/low respectively, see truth table.
4	V1S2	Logic input to the Tx Switch arm 1, selects/deselects Low Noise Amplifier if Logic high/low respectively, see truth table.
5	GND	Ground.
6	ANT	RF output to Antenna for the Tx/thru path and RF input from Antenna for the Rx/thru path, 50Ω nominal impedance.
7	GND	Ground.
8	V3S2	Logic input to the Tx Switch arm 3, selects/deselects PA if Logic high/low respectively, see truth table.
9	NC	Not connected.
10	GND	Ground.
11	PA VCC2	Collector power supply for Power Amplifier. Nominal 3.6V.
12	GND	Ground.
13	NC	Not connected.
14	PA BIAS	Power supply for the PA Bias Network. Nominal 3.6V.
15	GND	Ground.
16	PA VREG	Voltage set to PA Bias Level. Nomial 2.85V.
17	PA VCC1	Collector power supply for PA driver stage. Nominal 3.6V.
18	NC	Not connected.
19	NC	Not connected.
20	PA IN	RF Input to the PA, 50Ω nominal impedance, needs to be connected externally to PA IN to SWITCH PIN through as short as possible 50Ω transmission line.
21	PA IN to	PA input to be connected to the Rx Switch through this pin, 50Ω nominal Impedance.
	SWITCH	
22	V2S1	Logic input to the Rx switch arm 2, selects/deselects Thru path if Logic high/low respectively, see truth table.
23	V1S1	Logic input to the Rx switch arm 1, selects/deselects PA if Logic high/low respectively, see truth table.
24	GND	Ground.
25	RX OUT/TX IN	Transceiver IN/OUT.
26	GND	Ground.
27	V3S1	Logic input to the Rx switch arm 3, selects/deselects LNA if Logic high/low respectively, see truth table.
28	NC	Not connected.
29	LNA VCC	Collector power cupply for LNA. Nominal 3.0V.
30	LNA VSEL	A logic low selects the high gain mode of the LNA, logic high selects the low gain mode.
31	LNA VREF	Voltage to set the bias of the LNA, nominal 3.0V, can be adjusted to shut the LNA off or set the quiescent current of the LNA to desired level.
32	LNA IN	RF input to LNA, nominal impedance 50Ω , the Rx filter output should be connected to this pin, If Rx filter is bypassed, pin 2 should be connected to this pin htough an external 50Ω transmission line as short as possible.



Control Logic Table



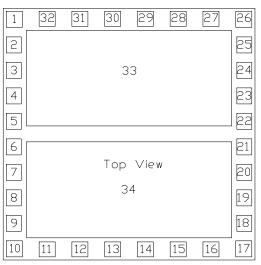
	SW1		SW2				LNA			PA		
V1S1	V2S1	V3S1	V1S2	V2S2	V3S2	LNA VSEL	LNA VREF	LNA VCC	PA VCC1 and 2	PA Bias	PA VREG	PATH
High	Low	Low	Low	Low	High	High	OFF	OFF	ON	ON	ON	Tx path thru PA
Low	High	Low	Low	High	Low	High	OFF	OFF	Х*	OFF	OFF	Tx/Rx Thru path with 10dB attenu- ation
Low	Low	High	High	Low	Low	Low	ON	ON	Х*	OFF	OFF	Rx path thru LNA (High gain mode)
Low	Low	High	High	Low	Low	High	ON	ON	Х*	OFF	OFF	Rx path thru LNA (Low gain mode)

High indicates logic High of >2.7V and Low indicates logic Low of <0.2V.

*An X means that the state of the pin doesn't matter.



Pin Out



Package Drawing

3.630 || -3.630 1.160±0.075 0.100 -2× -8.000±0.100-All Edges A A 6x 3.663-В В В В В В —2x 3.645 \bigcirc C C -2x 2.835 C D F ¢ С -2x 1.215 С D -2x 0.405 _ 8.000±0.100 С С -2x 0.405 -2x 1.215 G С С —2x 2.025 С -4x 3.663 -2x 3.645 Ε Ε 2x 3.630-В В В В

0.260

Ref

┥┝

3.663 3.645

2× 7

2.603-

Š

1.562-

SX

0.520-0.520-

2X **X**

0.000-0

1.562-

Š

2.603-

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Notes:

1. Shaded area represents Pin 1 location.

-2x 2.025

-1.685

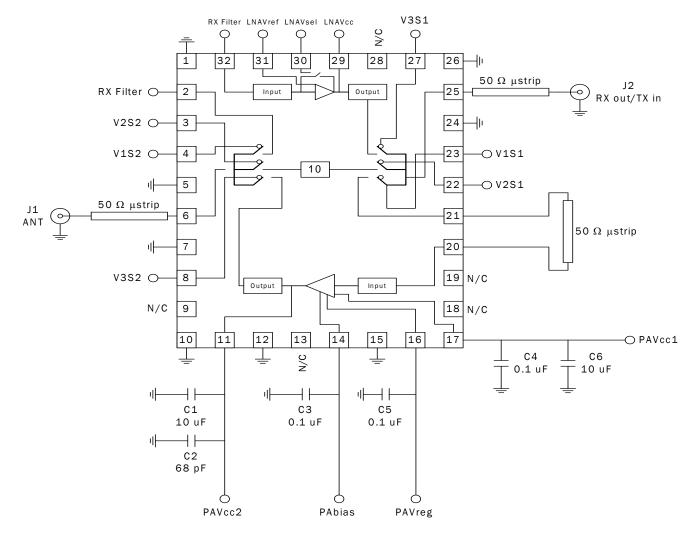
8 S

-2x 2.835

-1.693







Evaluation Board Schematic

Note: 1. If extra isolation is needed between Tx and Rx path, the filter can be used otherwise for \leq 50dB isolation, 50 Ω microstrip shoud be okay.





PCB Design Requirements

PCB Surface Finish

The PCB surface finish used for RFMD's qualification process is electroless nickel, immersion gold. Typical thickness is 3µinch to 8µinch gold over 180µinch nickel.

PCB Land Pattern Recommendation

PCB land patterns are based on IPC-SM-782 standards when possible. The pad pattern shown has been developed and tested for optimized assembly at RFMD; however, it may require some modifications to address company specific assembly processes. The PCB land pattern has been developed to accommodate lead and package tolerances.

PCB Solder Mask Pattern

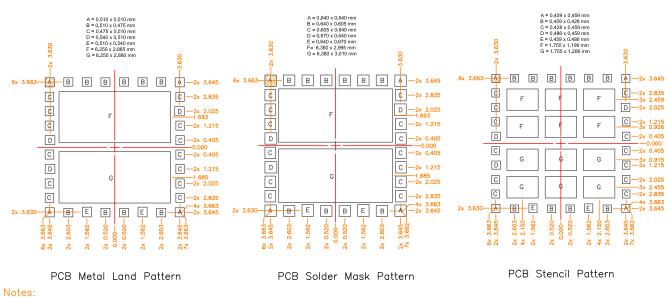
Liquid Photo-Imageable (LPI) solder mask is recommended. The solder mask footprint will match what is shown for the PCB metal land pattern with a 2mil to 3mil expansion to accommodate solder mask registration clearance around all pads. The center-grounding pad shall also have a solder mask clearance. Expansion of the pads to create solder mask clearance can be provided in the master data or requested from the PCB fabrication supplier.

Thermal Pad and Via Design

The PCB metal land pattern has been designed with a thermal pad that matches the die paddle size on the bottom of the device.

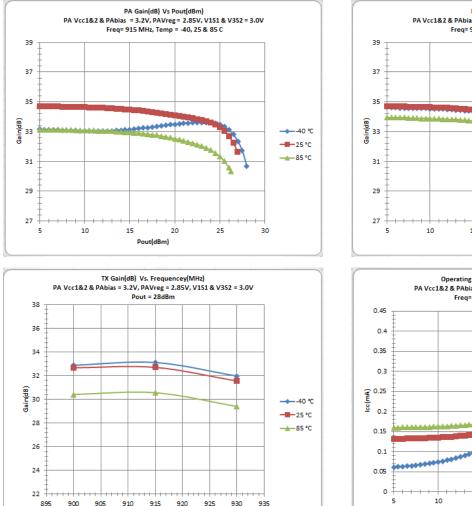
Thermal vias are required in the PCB layout to effectively conduct heat away from the package. The via pattern has been designed to address thermal, power dissipation and electrical requirements of the device as well as accommodating routing strategies.

The via pattern used for the RFMD qualification is based on thru-hole vias with 0.203mm to 0.330mm finished hole size on a 0.5mm to 1.2mm grid pattern with 0.025mm plating on via walls. If micro vias are used in a design, it is suggested that the quantity of vias be increased by a 4:1 ratio to achieve similar results.

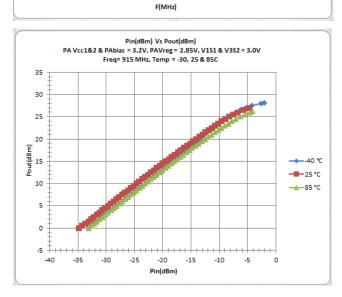


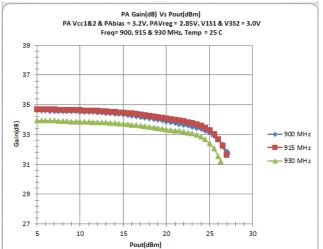


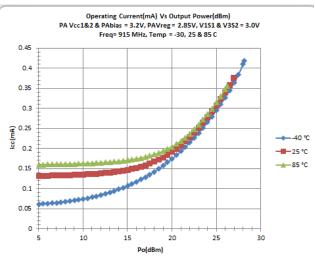


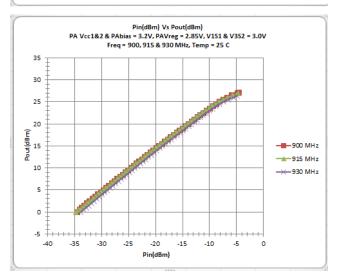


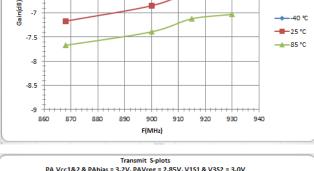
Typical Performance











RX Gain(dB) Vs. Frequencey(MHz) High Gain Mode PA Vcc1&2 & PAbias = 0V, PAVreg = 0V, LNA Vref & LNA Vcc = 3.0V

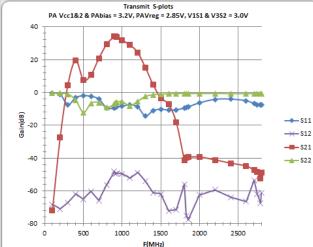
VSEL = 0V, V3S1 & V1S2 = 3.0V Input Power = -20 dBm

900 910

F(MHz)

RX Gain(dB) Vs. Frequencey(MHz) Low Gain Mode

PA Vcc1&2 & PAbias = 0V, PAVreg = 0V, LNA Vref & LNA Vcc = 3.0V VSEL = 3.0V, V3S1 & V1S2 = 3.0V Input Power = -20 dBm





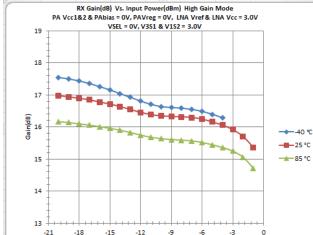
-40 °C 25 °C

930

940

920

85 °C



Pin(dBm)

RX Gain(dB) Vs. Input Power(dBm) Low Gain Mode PA Vcc1&2 & PAbias = 0V, PAVreg = 0V, LNA Vref & LNA Vcc = 3.0V VSEL = 3.0V, V351 & V152 = 3.0V

-12

Receive S-plots

PA Vcc1&2 & PAbias = 0V, PAVreg = 0V, V3S1 & V1S2 = 3.0V

-9

Pin(dBm)

-6

-3

0

.....

....

-40 °C

-85 °C

-S11

→**-**S12

S21

÷

Typical Performance

18

17.5

17

16.5

16

15.5

15

-5

-5.5

-6

-6.5

860 870 880 890

Gain(dB)

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-4.5

-5

-5.5

-6 Gain(dB)

-6.5

-7

-7.5

-8

-8.5 -9

30

15

0

-15

Gain(dB) ^{\C}

-45

-60

-75 -90

0

300

600

900

F(MHz)

1200

1500

1800

-21

-18

-15





RoHS* Banned Material Content

Yes
0.038
0547
А
e3

Bill of Materials	Parts Per Million (PPM)									
	Pb	Cd	Hg	Cr VI	PBB	PBDE				
Die	0	0	0	0	0	0				
Molding Compound	0	0	0	0	0	0				
Lead Frame	0	0	0	0	0	0				
Die Attach Epoxy	0	0	0	0	0	0				
Wire	0	0	0	0	0	0				
Solder Plating	0	0	0	0	0	0				

This RoHS banned material content declaration was prepared solely on information, including analytical data, provided to RFMD by its suppliers, and applies to the Bill of Materials (BOM) revision noted above.

* DIRECTIVE 2002/95/EC OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment

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